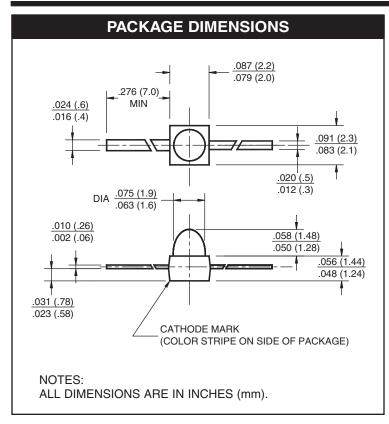
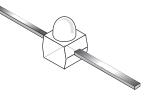


SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS



FEATURES

- Subminiature T-3/4 transfer molded
- · Low package profile
- Axial leads
- Wide viewing angle
- SMT versions



DESCRIPTION

These T-3/4 subminiature LED lamps feature a squarebase, transfer molded package for surface mount applications. A tinted diffused or water clear epoxy lens — available in AIGaAs red, high-efficiency red, green, and yellow — produces wide-angle beam emission and sharp on/off contrast. They are available with gullwing lead bends for top mounting, as well as yoke lead bends and Z-bends for mounting to the back of a PCB.

Parameter	HLMP-6305A MV6700A	HLMP-6405A MV6300A	HLMP-6505A MV6400A	HLMP-Q101A HLMP-Q105A HLMP-Q150A HLMP-Q155A	Units			
Power Dissipation	135	85	135	85	mW			
Average Forward Current	30	20	30	30	mA			
Peak Forward Current (1 µS pulsewidth, 0.1% DF)	90	60	90	300	mA			
Lead Soldering Time at 260°C	5	5	5	5	sec			
Operating Temperature	-55 to +100	-55 to +100	-50 to +100	-20 to +100	°C			
Storage Temperature	-55 to +100	-55 to +100	-50 to +100	-20 to +100	°C			



SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS

HIGH EFF. RED YELLOW GREEN AIGaAs RED	HLMP-6405A HLMP-6505A HLMP-Q105A	Water Clear Water Clear Water Clear Water Clear Red Diffused	MV6700A MV6300A MV6400A HLMP-Q150A HLMP-Q155A	Red Diffused Yellow Diffused Green Diffused Red Diffused Water Clear
	HLMP-Q101A	Red Diffused	HLMP-Q155A	Water Clear

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)						
Part Number QTLP-	MV6700A	MV6300A	MV6400A	HLMP-Q150A	Condition	
Luminous Intensity (mcd)					I _F = 10mA	
Minimum	1.0	1.0	1.0	1.0*		
Typical	3.0	3.0	3.0	1.8*	*Tested at I _F = 1mA	
Forward Voltage (V)					I _F = 10mA	
Maximum	3.0	3.0	3.0	1.8*		
Typical	1.8	2.0	2.0	1.6*	*Tested at I _F = 1mA	
Peak Wavelength (nm)	635	585	565	660	I _F = 10mA	
Spectral Line Half Width (nm)	40	36	28	20	I _F = 10mA	
Reverse Voltage (V)	5	5	5	5	I _R = 100μA	
Viewing Angle (°)	50	50	50	50	I _F = 10mA	

ELECTRICAL / OPTICAL CHARACTERISTICS (T _A =25°C)						
Part Number QTLP-	HLMP- 6305A	HLMP- 6405A	HLMP- 6505A	HLMP- Q101A	HLMP-Q105A/ Q155A	Condition
Luminous Intensity (mcd)						l _F = 10mA
Minimum	3.0	3.0	3.0	22**	20.0**/2.0*	**Tested at I _F = 1mA
Typical	12.0	12.0	12.0	45**	50.0**/4.0*	**Tested at I _F = 20mA
Forward Voltage (V)						I _F = 10mA
Maximum	3.0	3.0	3.0	2.4**	2.4**/1.8*	*Tested at I _F = 1mA
Typical	1.8	2.0	2.0	1.8**	1.8**/1.6*	**Tested at I _F = 20mA
Peak Wavelength (nm)	635	585	565	660	660	I _F = 10mA
Spectral Line Half Width (nm)	40	36	28	20	20	I _F = 10mA
Reverse voltage (V)	5	5	5	5	5	I _R = 100μΑ
Viewing Angle (°)	25	25	25	50	25	I _F = 10mA



SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS

HIGH EFF. RED YELLOW GREEN AIGaAs RED	HLMP-6405A HLMP-6505A HLMP-Q105A		MV6700A MV6300A MV6400A HLMP-Q150A HLMP-Q155A	
	HLMP-Q101A	Red Diffused	HLMP-Q155A	Water Clear

TYPICAL PERFORMANCE CURVES

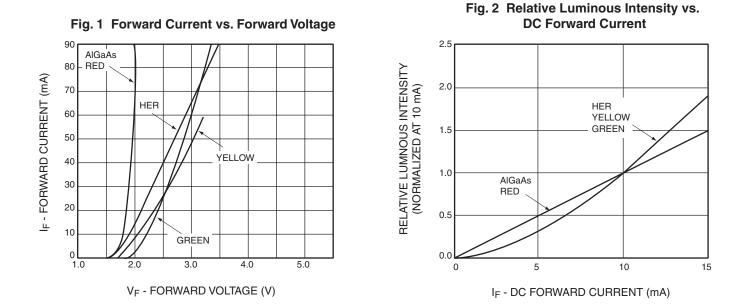
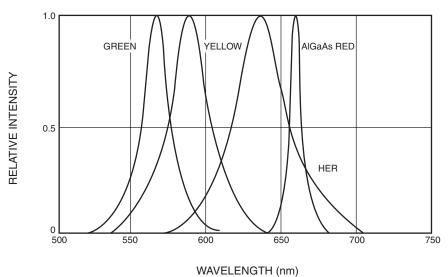


Fig. 3 Relative Intensity vs. Peak Wavelength

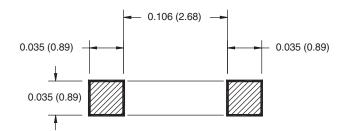




SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS

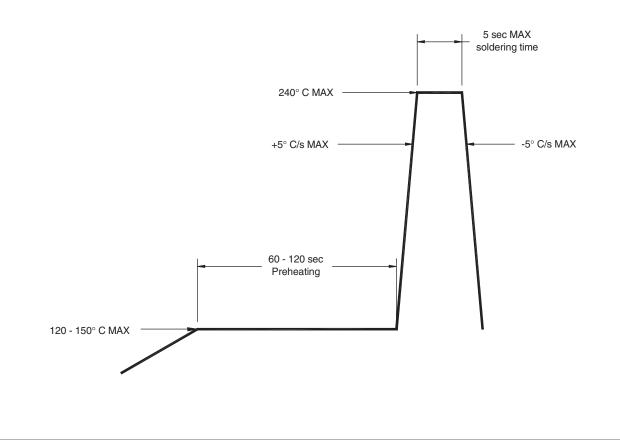
HIGH EFF. RED YELLOW GREEN AIGaAs RED	HLMP-6405A HLMP-6505A HLMP-Q105A		MV6700A MV6300A MV6400A HLMP-Q150A HLMP-Q155A	
	HLMP-Q101A	Red Diffused	HLMP-Q155A	Water Clear

RECOMMENDED PRINTED CIRCUIT BOARD PATTERN



For Gullwing Lead Bend

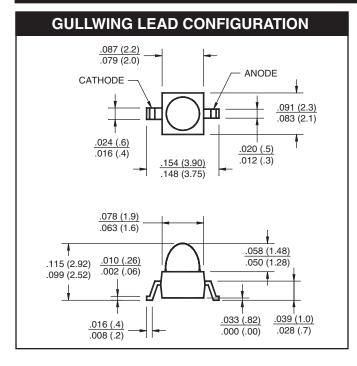
RECOMMENDED REFLOW SOLDERING PROFILE





SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS

HIGH EFF. RED HLMP-6305A	Water Clear	MV6700A	
YELLOW HLMP-6405A	Water Clear	MV6300A	
GREEN HLMP-6505A	Water Clear	MV6400A	
AIGaAs RED HLMP-Q105A	Water Clear	HLMP-Q150A	
HLMP-Q101A	Red Diffused	HLMP-Q155A	



FEATURES

- Available in Gullwing, Yoke and Z-bend lead formings
- Compatible with automatic placement equipment
- Compatible with vapor phase reflow soldering processes
- Long life solid state reliability
- Reel and tape or bulk packaging available

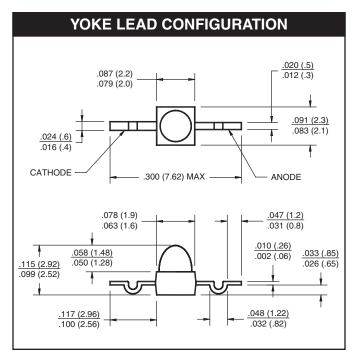
DESCRIPTION

These subminiature solid state lamps are transfer molded in an axial lead package. They are available in yellow, green, high efficiency red and AIGaAs red in both diffused and water clear lens.

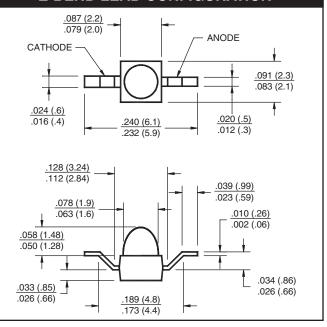
Automatic placement equipment can be used to mount the LEDs on the PC board. The lamps can be mounted using either batch or in line vapor phase reflow solder processes.

NOTES:

ALL DIMENSIONS ARE IN INCHES (mm)



Z-BEND LEAD CONFIGURATION



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SUBMINIATURE T-3/4 LED DIFFUSED AND CLEAR LAMPS

HIGH EFF. RED YELLOW GREEN AIGaAs RED	HLMP-6405A HLMP-6505A HLMP-Q105A		MV6700A MV6300A MV6400A HLMP-Q150A	
		Red Diffused	HLMP-Q155A	

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